10.4

CM1513FC TYPE

FEATURE

- 1. Capable of handling the highest current(up to 15A) of any chip-type common mode filter
- 2. Noise is greatly suppressed.

Applications

1. Used for power line noise suppression for any electric devices. Used to counter adapter/battery line noise for relatively large electronic devices such as notebook, stand-alone word processor, etc.

Shape and Dimension Schematics and Land Patterns(mm) 1 XXX2 3 No polarity 17.0

 $A=15.5\pm0.50 \text{ mm}$; $B=13.0\pm0.50 \text{ mm}$; C=6.60 mm Max;

D=9.00 mm Ref.; E=2.60 mm Ref.; F=3.80 mm Ref. G=2.50 mm Ref.;

Specification

	Common mod	de Impedance	DC Resistance	Rated	Rated	Insulation Resistance
Part number	Z(Ω) at 100MHz		Max.	Current	Voltage	Min.
	Min.	Тур.	(mΩ)	(A)	(V)	(ΜΩ)
CM1513FC-301	225	300	5.0	15.0	80	10
CM1513FC-551	400	550	6.0	12.0	80	10
CM1513FC-701	500	700	7.0	10.0	80	10
CM1513FC-102	800	1000	10.0	9.0	80	10
CM1513FC-152	1200	1500	23.0	5.0	80	10

Note1. Measurement ambient temperature of Impedance, DCR and IDC : at 25° C

Note2. Packing: reel; Quantity: 350pcs/reel

GENERAL CHARACTERISTICS

- 1. Operating temperature range: -40 TO + 125°C(Includes temperature when the coil is heated)
- 2. External appearance: On visual inspection, the coil has no external defects.
- Terminal strength: After soldering. Between copper plate and terminals of coil. Push in two directions of X.Y withstanding at below conditions.

Terminal should not peel off. (refer to figure at right) 5. 0N 60 sec.

- 4. Insulating resistance: Over $100M\Omega$ at 100V D.C. between coil and core.
- 5. Dielectric strength: No dielectric breakdown at 100V D.C. for 1 minute between coil and core.
- 6. Temperature characteristics: Inductance coefficient (0~2,000)x10-6/°C(-25~+80°C), inductance deviation within±5.0%, after 96 hours
- 7. Humidity characteristics(Moisture Resistance): Inductance deviation within ±5%, after 96 hours in 90~95% relative humidity at 40 ±2°C and 1 hour drying under normal condition.
- 8. Vibration resistance: Inductance deviation within ±5%, after vibration for 1 hour. In each of three orientations at sweep vibration (10~55~10 Hz) with 1.5mm P-P amplitudes.
- 9. Shock resistance: Inductance deviation within ±5%, after being dropped once with 981m/s2 (100G) shock attitude upon a rubber block method shock testing machine, in three different orientations.
- 10. Resistance to Soldering Heat: 260°C, 10 seconds(See attached recommend reflow)
- 11. Storage condition: Temperature Range: 0°C ~ 35°C ; -40°C ~ 125°C (after PCB) , Humidity Range: 50% ~ 70% RH
- 12. Use components within 12 months. If 12 months or more have elapsed, check solderability before use.
- 13. Reflow profile recommend:

Lead-free heat endurance test

Lead-free the recommended reflow condition



